
Description

Features.	Applications.
◆ Super high Flux output and high Luminance	◆ General Lighting
◆ Adapt to large current circuit	◆ Architectural lighting
◆ Low thermal resistance:12°C/W	◆ Decorative lighting
◆ Wide viewing angle , Integrated package	◆ Flood lights, cast light lamps
◆ RoHS compliant	◆ Street lamp, tunnel lamp

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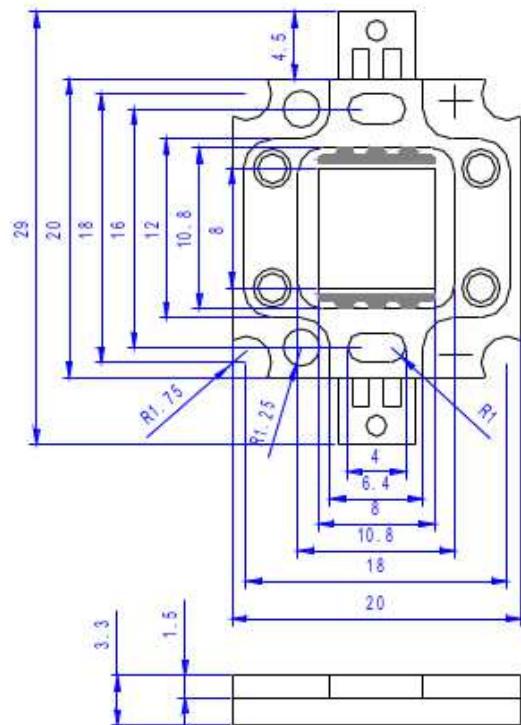
Typical Characteristic Curves (2)

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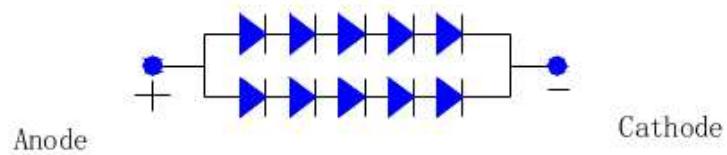
Outline Dimensions

1、Dome Type



2、Circuit diagram

INTERNAL CIRCUIT DIAGRAM



Notes :

1. All dimensions are in millimeters.(tolerance: ± 0.2)

2. Dimension Scale:1:1

*The appearance and specifications of the product may be changed for improvement without notice.

Parameters

Electrical-Optical Characteristics at Ta=25°C

Parameter	Symbol	Min	Typ	Max	Unit
Wavelength	λ_D	400	~	410	nm
Forward Voltage	V_F	15	~	18	V
Power Dissipation	P_D	10.50	~	12.6	W
View Angle	$2\theta_{1/2}$	~	120	~	deg.
Thermal Resistance	$R_{\theta J-B}$	~	12	~	°C/W

Absolute Maximum Ratings

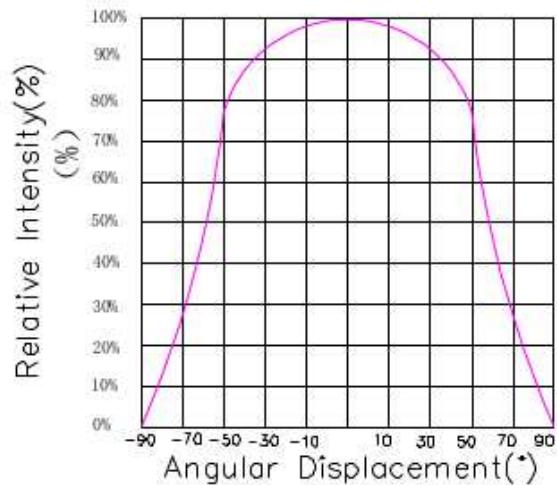
Parameter	Symbol	Value	Unit
Forward Current	I_F	700	mA
Junction Temperature	T_j	115	°C
Operating Temperature	T_{opr}	-40~+60	°C
Storage Temperature	T_{stg}	0~+60	°C
ESD Sensitivity	~	±2,000V HBM	~
Temperature Coefficient of voltage	~	-5	mV/°C
DC Pulse Current(@ 1 KHz, 10% duty cycle)	I_{FP}	1000	mA
Reverse Voltage	V_R	Not designed for reverse operation	

*Notes

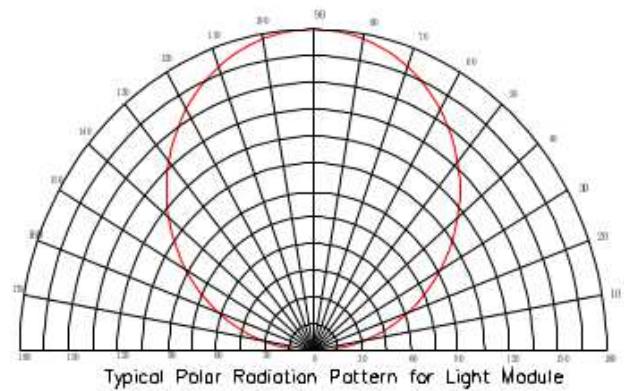
1. Tolerance of Luminous Flux is ±3%.
2. Tolerance of Forward Voltage is ±0.1V.

Typical Characteristic Curves(1)

1. Typical Light Distribution Curve

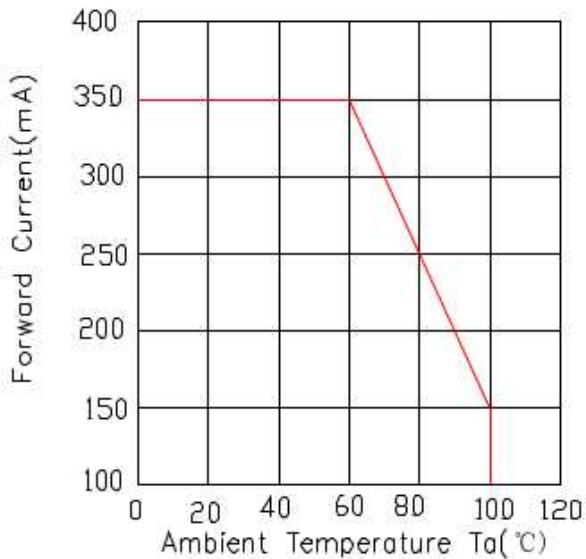


2. Typical Light-Emitting Angle Radiation Pattern

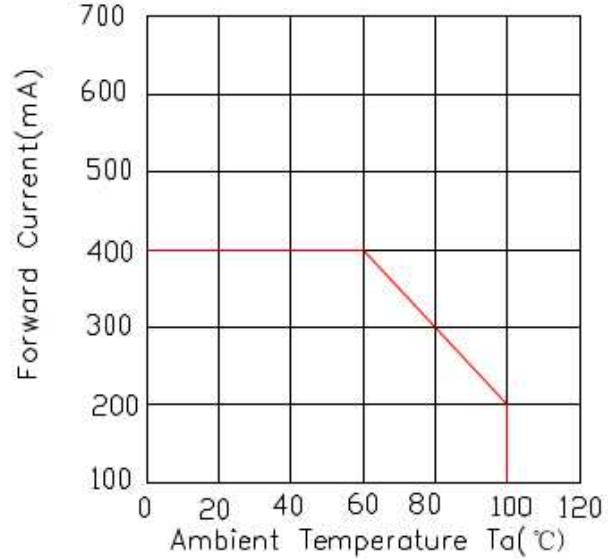


3. Forward Current Derating Curve,Derating based on Timax=115°C

3-1: White,Royal Blue , Blue, Green

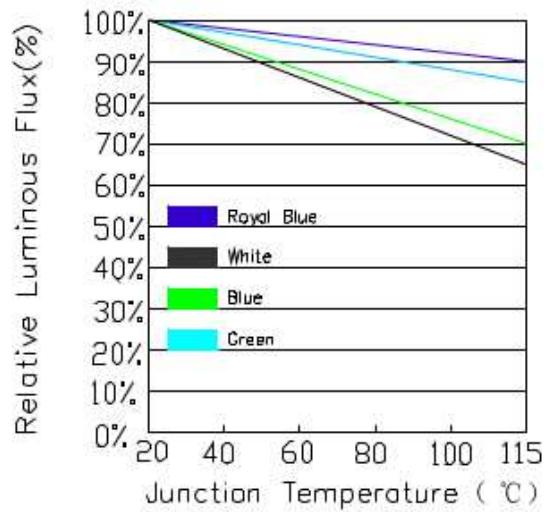


3-2: Amber, Red

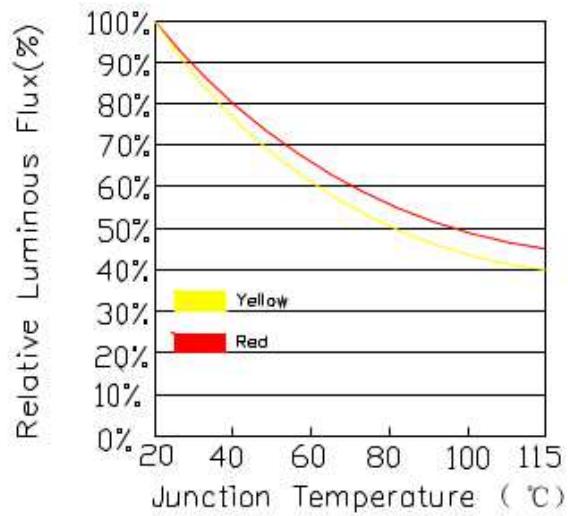


Typical Characteristic Curves(2)

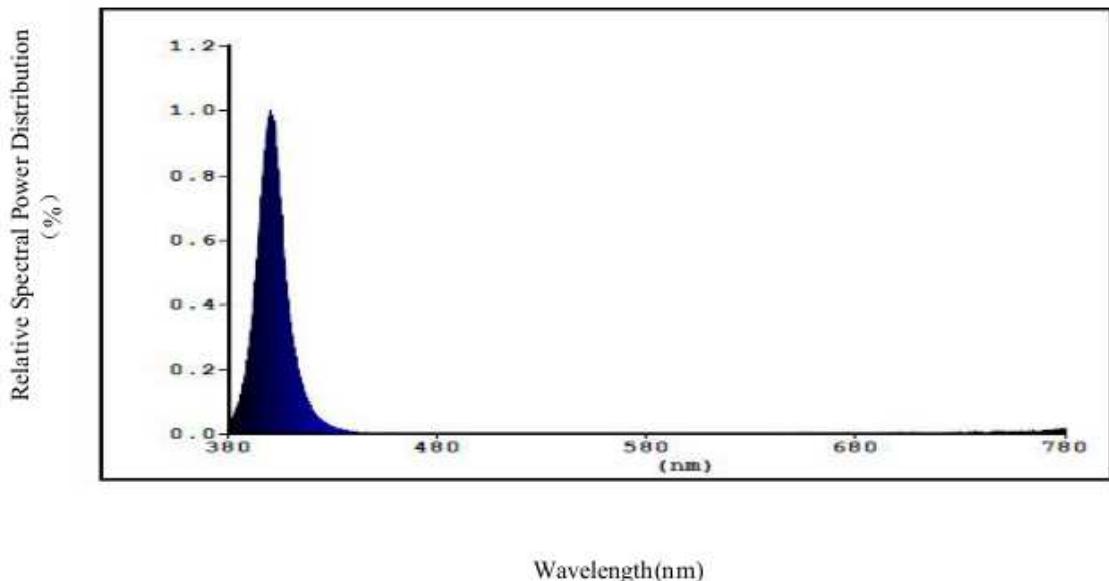
4-1. Relative Flux vs. Junction Temperature White, Royal Blue, Blue, Green



4-2. Relative Flux vs. Junction Temperature Amber, Red



5. Relative Spectral Power Distribution



Wavelength(nm)

Reliability Test Items And Conditions

Test Items	Test Condition	Test Hours Cycles	Sample Size	Ac/Re
DC Aging	Ta=25 °C IF=700mA	1000H	22	0/1
Hot and cold shock	-40 °C/30min +100 °C/30min	100Cycles 100	22	0/1
High Temperature Storage	Ta=100 °C	1000H	22	0/1
High Temperature High Humidity	85 °C/85%RH	1000H	22	0/1
Low Temperature Storage	Ta=-40 °C	1000H	22	0/1
ESD(HBM)	2000V HBM	1Time	10	0/1

Criteria For Judging the Damage

Items	Symbol	Test Condition	Criteria For Judging Damage
Forward Voltage	V _F	I _F =700mA	Initial Data±10%
Reverse Current	I _R	V _R =25V	I _R ≤20μA
Luminous Flux	Φ _V	I _F =700mA	Average Φ _V degradation≤30% Single LED Φ _V degradation≤50%

Soldering Condition

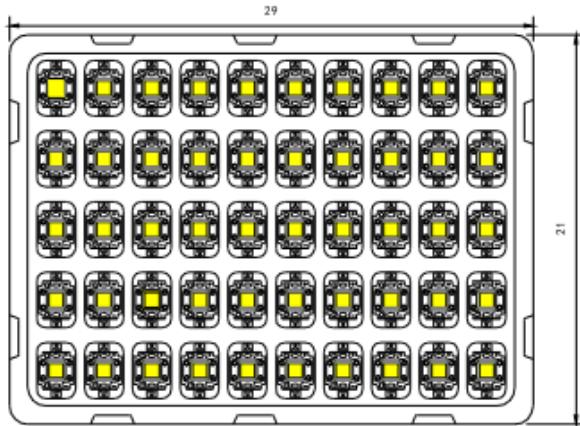
Only By Manual Welding

Temperature	Soldering time
Highest 350°C	3ses once

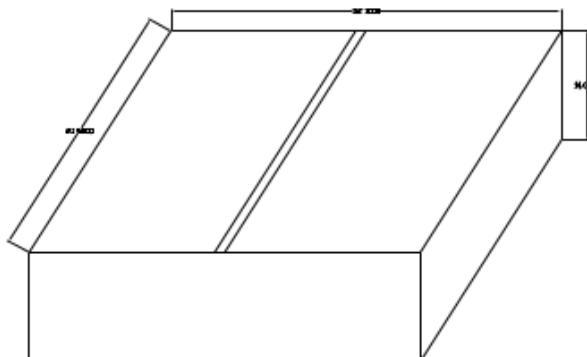
*Notes

Module holder products don't use reflow soldering.

Packing Dimension



Inner pack



Outer pack